

## STS5PF30L

## P-channel 30V - 0.045Ω - 5A SO-8 STripFET™ Power MOSFET

### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STS5PF30L	30V	<0.055Ω	5A

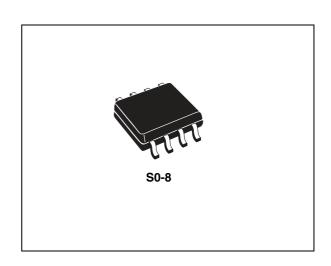
- Conduction losses reduced
- Switching losses reduced
- Low threshold drive
- Standard outline for easy automated surface mount assembly

### **Description**

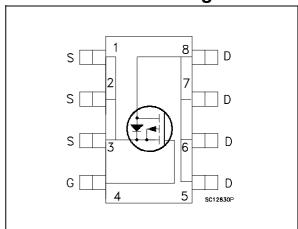
This Power MOSFET is the latest development of STMicroelectronics unique "single feature size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## **Applications**

■ Switching application



## Internal schematic diagram



#### Order code

Part number	Marking	Package	Packaging	
STS5PF30L	STS5PF30L S5PF30L		Tape & reel	

Contents STS5PF30L

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STS5PF30L Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (v <sub>gs</sub> = 0)	30	V
V <sub>GS</sub>	Gate- source voltage	±16	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	5	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	4	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	20	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C dual operating	2.5	W
T <sub>J</sub>	Junction temperature	-55 to 150	°C
T <sub>stg</sub>	Storage temperature range	150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Note:

For the p-channel Power MOSFET actual polarity of voltages and current has to be reversed

Table 2. Thermal data

R <sub>thj-a</sub>	<sup>(1)</sup> Thermal resistance junction-ambient Max	50	°C/W	
TL	Maximum lead temperature for soldering purpose	300	°C	

<sup>1.</sup> Mounted on FR-4 board (t≤10sec)

Electrical characteristics STS5PF30L

# 2 Electrical characteristics

( $T_{CASE}$ =25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu\text{A},  V_{GS} = 0$	30			V
I <sub>DSS</sub>	Zero gate voltage Drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ =Max rating, $T_{C}$ =125°C			1 10	µА µА
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 16V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.6	2.5	V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2.5A$ $V_{GS} = 4.5V, I_D = 2.5A$		0.045 0.065	0.055 0.075	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>DS</sub> = 15V, I <sub>D</sub> =2.5A		10		S
C <sub>iss</sub>	Input capacitance			1350		pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25V, f = 1 MHz,$		490		pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0		130		pF
Qg	Total gate charge	$V_{DD} = 24V, I_D = 5A,$		12.5	16	nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 24V, I_D = 5A,$ $V_{GS} = 5V$		5		nC
$Q_{gd}$	Gate-drain charge	(see Figure 14)		3		nC

<sup>1.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD}$ =15 V, $I_{D}$ =2.5A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =4.5V (see Figure 13)		25 35		ns ns
t <sub>d(off)</sub> t <sub>f</sub>	Turn-off Delay Time Fall Time	$V_{DD}$ =15 V, $I_{D}$ =2.5A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =4.5V (see Figure 13)		125 35		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				5	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				20	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 5A, V_{GS} = 0$			1.2	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 5A, $V_{DD}$ = 15V di/dt = 100A/ $\mu$ s, $T_j$ = 150°C (see Figure 15)		45 36 1.6		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STS5PF30L

## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

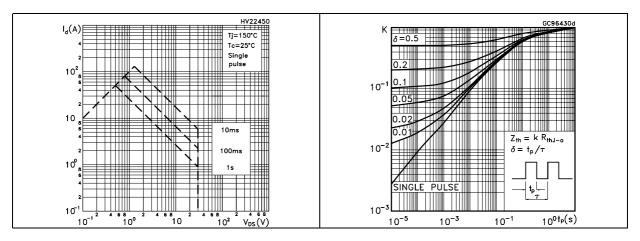


Figure 3. Output characteristics

Figure 4. Transfer characteristics

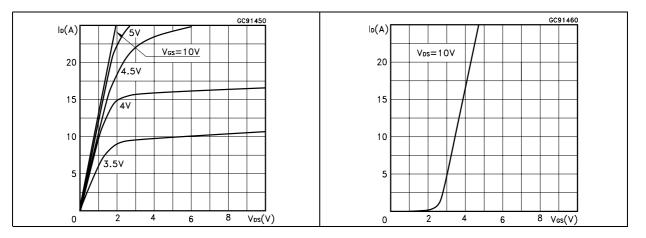


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

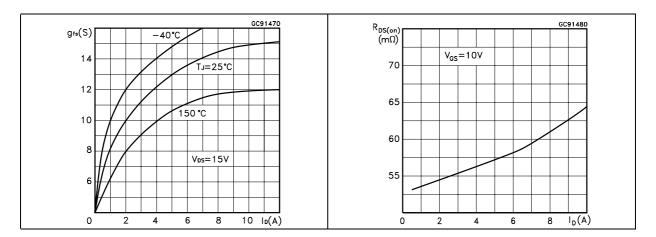


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

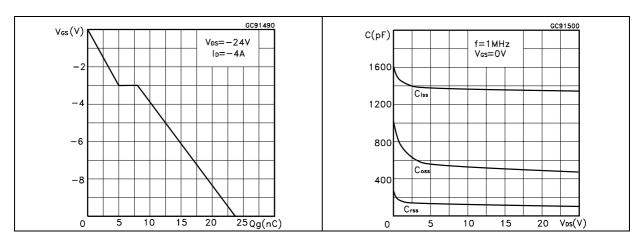


Figure 9. Normalized gate threshold voltage Figure 9. vs temperature

Figure 10. Normalized on resistance vs temperature

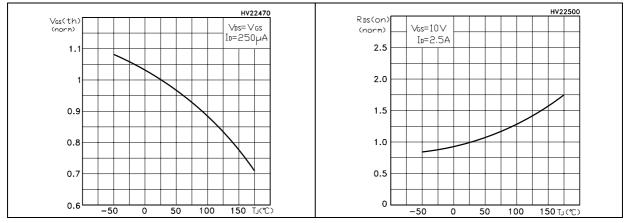
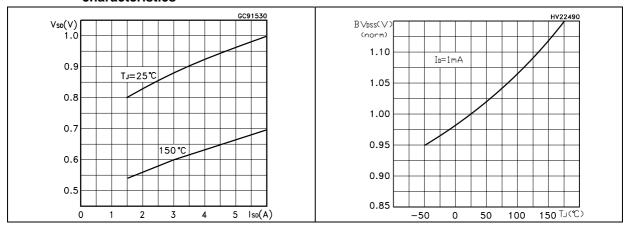


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized BV<sub>DSS</sub> vs temperature



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Test circuit STS5PF30L

# 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

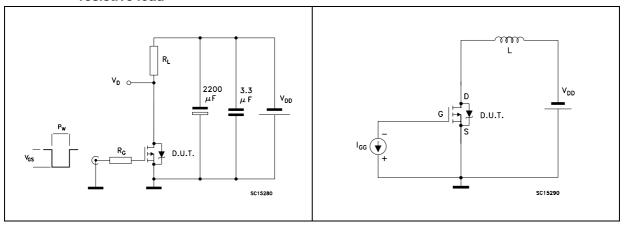
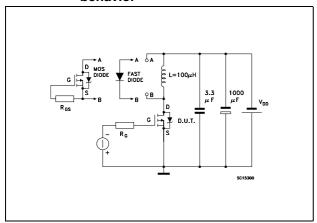


Figure 15. Test circuit for diode recovery behavior



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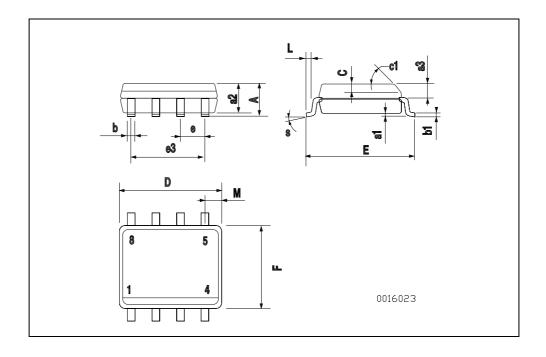
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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

### **SO-8 MECHANICAL DATA**

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (r	nax.)	•	•



STS5PF30L Revision history

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
06-Feb-2007	4	The document has been reformatted

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